Electronic Patent Application Fee Transmittal							
Application Number:	10	10824111					
Filing Date:	14	14-Apr-2004					
Title of Invention:	WAFER-LEVEL ELECTRONIC MODULES WITH INTEGRAL CONNECTOR CONTACTS						
First Named Inventor/Applicant Name:	Seung Duk Baek						
Filer:	Robert M. Meeks/Susan Freedman						
Attorney Docket Number:	5649-1279						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1440	1440		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1740